

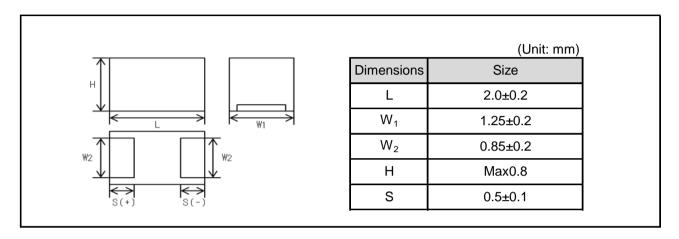
Conductive polymer chip capacitors (New Bottom surface electrode type: Extra Large capacitance)

TCSO series PE case

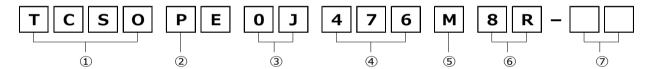
Features

- 1) Conductive polymer used at the cathode for ultra-low ESR.
- 2) New package structure results in the largest capacitance.
- 3) Compact, low profile, ultra-high capacitance contributes to smaller, thinner sets with greater functionality.
- 4) Conductive polymer has a self-healing function that prevents failure, resulting in safe, high reliability operation.

Dimensions



Part No. Explanation



1 Series name **TCSO**

2 Case style

PE: 2012-2012(08)size

3 Rated voltage

rtated voltage							
CODE	Rated voltage(V)						
0E	2.5						
0G	4						
0J	6.3						
0K	8						
1A	10						
1C	16						
1D	20						
1E	25						
1V	35						
1H	50						

4 Nominal capacitance

Nominal capacitance in pF in 3 digits: 2 significant figures followed by the figure representing the number of 0's.

5 Capacitance tolerance

M: ±20%

6 Taping

8: Tape width

R: Positive electrode on the side opposite to sprocket hole

7 Discrimination code

Datasheet

Rated table

 $ESR(m\Omega)$

Capaci	tance	Rated voltage (V.DC)							
· (µF	=)	4	6.3	8	10	16	20	25	35
1	(105)								
1.5	(155)								
2.2	(225)								
3.3	(335)							☆ 500	
4.7	(475)								
6.8	(685)								
10	(106)								
15	(156)								
22	(226)								
33	(336)			150					
47	(476)		☆ 150						
68	(686)								
100	(107)								

Marking

The indications listed below should be given on the surface of a capacitor.

- (1) Polarity: The polarity should be shown by bar. (on the anode side)
- (2) Rated DC voltage: A voltage code is shown as below table.
- (3) Capacitance: A capacitance code is shown as below table.

Voltage Code	Rated DC			
Voltage Code	Voltage (V)			
е	2.5			
g	4			
j	6.3			
k	8			
Α	10			
С	16			
D	20			
E	25			
V	35			
Н	50			

Capacitance	Nominal	Capacitance	Nominal
Code	Capacitance (µF)	Code	Capacitance (µF)
<u>E</u>	0.15	е	15
<u>N</u>	0.33	j	22
<u>S</u>	0.47	n	33
Α	1.0	S	47
E	1.5	>	68
J	2.2	а	100
N	3.3	Ф	150
S	4.7	j	220
W	6.8	c	330
а	10	s	470

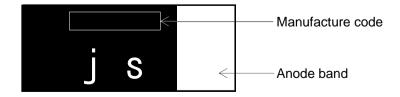
Visual typical example

voltage code and capacitance code are variable with parts number.

[TCSO series PE case]

EX.)
$$\frac{j}{(1)}$$
 $\frac{s}{(2)}$

- (1) voltage code
- (2) capacitance code



Characteristics

Item		Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Operating Temp	erature	-55℃~+105℃	Voltage reduction when temperature exceeds +85°C				
Maximum operat temperature with voltage derating	-	+85℃					
Rated voltage (V	'.DC)	Refer to " Standard list ".	at 85℃				
Category voltage	e (V.DC)	Refer to " Standard list ".	at 105℃				
Surge voltage (V	'.DC)	Refer to " Standard list ".	at 85℃				
DC Leakage cur	rent	Shall be satisfied the value on "Standard list ".	As per 4.9 JIS C 5101-1 As per 4.5.1 JIS C 5101-3 Voltage: Rated voltage for 5min				
Capacitance tole	erance	Shall be satisfied allowance range. ±20%	As per 4.7 JIS C 5101-1 As per 4.5.2 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit				
Tangent of loss a (Df,tanδ)	angle	Shall be satisfied the value on "Standard list ".	As per 4.8 JIS C 5101-1 As per 4.5.3 JIS C 5101-3 Measuring frequency: 120 ± 12Hz Measuring voltage: 0.5Vrms + 1.5V.DC Measuring circuit: DC Equivalent series circuit				
ESR		Shall be satisfied the value on "Standard list ".	As per 4.10 JIS C 5101-1 As per 4.5.4 JIS C 5101-3 Measuring frequency : 100 ± 10kHz Measuring voltage : 0.5Vrms or less Measuring circuit : DC Equivalent series circuit				
Resistance to Soldering heat	Appe- arance	There should be no significant abnormality. The indications should be clear.	As per 4.14 JIS C 5101-1 As per 4.6 JIS C 5101-3 Dip in the solder bath				
	L.C.	Less than 300% of initial limit.	Solder temp: 240 ± 5°C Duration: 10 ± 0.5s				
	⊿C/C	Within ±20% of initial value.	Repetition: 1 After the specimens, leave it at room temperature				
	DF (tanδ)	Less than 300% of initial limit.	for over 24h and then measure the sample.				
Temperature cycle	Appe- arance	There should be no significant abnormality. The indications should be clear.	As per 4.16 JIS C 5101-1 As per 4.10 JIS C 5101-3 Repetition: 5 cycles				
	L.C.	Less than 1000% of initial limit.	(1 cycle : steps 1 to 4) without discontinuation.				
	⊿C/C	Within ±20% of initial value.	Temp. Time 1 -55±3℃ 30±3min				
	DF (tanδ)	Less than 300% of initial limit.	2 Room Temp. 3min or less 3 105±2℃ 30±3min				
			4 Room Temp. 3min or less After the specimens, leave it at room temperature for over 24h and then measure the sample.				



Item	ı	Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)				
Moisture	Appe-	There should be no significant	As per 4.22 JIS C 5101-1				
resistance	arance	abnormality.	As per 4.12 JIS C 5101-3				
		The indications should be clear.	After leaving the sample under such atmospheric				
	L.C.	Less than 300% of initial limit.	condition that the temperature and humidity are				
			40±2°C and 90 to 95% RH, respectively, for				
	⊿C/C	Within +30/-20% of initial value.	500+12/0h leave it at room temperature for				
			over 24h and then measure the sample.				
	DF	Less than 300% of initial limit.					
	(tanδ)						
Temperature	Temp.:-	55°C	As per 4.29 JIS C 5101-1				
Stability	⊿C/C	Within 0/-20% of initial value.	As per 4.13 JIS C 5101-3				
		Within 0/-30% of initial value.(PE0K336)					
	DF	Shall be satisfied the value on					
	(tanδ)	" Standard list "					
	L.C.	_					
	Temp.:-	-105°C					
	⊿C/C	Within +50/0% of initial value.					
	DF	Shall be satisfied the value on					
	(tanδ)	" Standard list "					
	L.C.	Less than 1000% of initial limit.					
Surge	Appe-	There should be no significant	As per 4.26JIS C 5101-1				
voltage	arance	abnormality.	As per 4.14JIS C 5101-3				
		The indications should be clear.	Apply the specified surge voltage via the serial				
	L.C.	Less than 200% of initial limit.	resistance of 1kΩ ever 5±0.5 min. for 30±5 s.				
		Less than 300% of initial limit.(PE0K336)	each time in the atmospheric condition of				
	⊿C/C	Within ±20% of initial value.	85±2°C. Repeat this procedure 1,000 times.				
			After the specimens, leave it at room temperature				
	DF	Less than 200% of initial limit.	for over 24h and then measure the sample.				
	(tanδ)	Less than 300% of initial limit.(PE0K336)					
Loading at	Appe-	There should be no significant	As per 4.23 JIS C 5101-1				
High	arance	abnormality.	As per 4.15 JIS C 5101-3				
temperature		The indications should be clear.	After applying the rated voltage for 1000+72/0 h				
	L.C.	Less than 400% of initial limit.	without discontinuation via the serial resistance				
			of 3Ω or less at a temperature of 85±2°C, leave				
	⊿C/C	Within ±20% of initial value.	the sample at room temperature / humidity for				
		Within +20/-30% of initial value.(PE0K336)	over 24h and measure the value.				
	DF	Less than 300% of initial limit.					
	(tanδ)						

Item		Performance	Test conditions (based on JIS C 5101-1 and JIS C 5101-3)			
Terminal strength	Capa- citance	The measured value should be stable.	As per 4.35 JIS C 5101-1			
Suengui	Appe- arance	There should be no significant abnormality.	As per 4.9 JIS C 5101-3 A force is applied to the terminal until it bends to 1mm and by a prescribed tool maintains the condition for 5s. (See the figure below)			
			F(Apply force) R230 F(Apply force) 1.0mm			
Adhesiveness		The terminal should not come off.	As per 4.34 JIS C 5101-1 As per 4.8 JIS C 5101-3 Apply force of 2N in the two directions shown in the figure below for 10±1s after mounting the terminal on a circuit board.			
			Apply force A circuit board			
Dimensions		Refer to "External dimensions".	Measure using a caliper of JIS B 7507 Class 2 or higher grade.			
Resistance to solvents		The indication should be clear.	As per 4.32 JIS C 5101-1 As per 4.18 JIS C 5101-3 Dip in the isopropyl alcohol for 30±5s, at room temperature.			
Solderability		3/4 or more surface area of the solder coated terminal dipped in the soldering bath should be covered with the new solder.	As per 4.15.2 JIS C 5101-1 As per 4.7 JIS C 5101-3 Dip speed=25±2.5mm / s Pre-treatment (accelerated aging): Leave the sample on the boiling distilled water for 1h. Solder temp.: 245±5°C Duration: 3±0.5s Solder: M705 Flux: Rosin 25% IPA 75%			
Vibration Capacitance Appearance		Measure value should not fluctuate during the measurement. There should be no significant abnormality.	As per 4.17 JIS C 5101-1 Frequency: 10 to 55 to 10Hz/min. Amplitude: 1.5mm Time: 2h each in X and Y directions Mounting: The terminal is soldered on a print circuit board.			

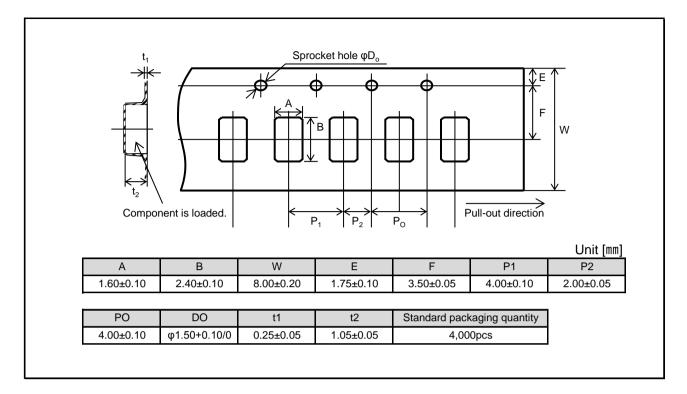


Standard products list

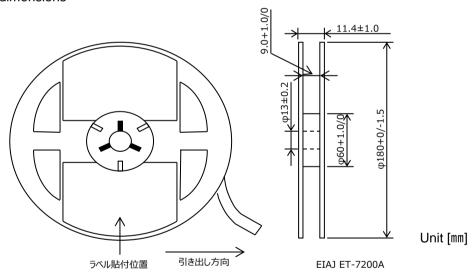
	Rated	Category	Surge	Cap.	Tole-	Leakage		tanδ		ESR	Max
	voltage	voltage	voltage		rance	current		120Hz			allowable
	85°C	105°C	85°C	120Hz		25℃				100kHz	ripple
Part No.						1WV	-55℃	25℃	105℃		current
						5min					≦45°C
											100kHz
	(V)	(V)	(V)	(µF)	(%)	(µA)	(%)	(%)	(%)	(mΩ)	(mArms)
* TCSOPE0J476M8R-ZF1	6.3	5	8	47	±20	29.7	15	15	20	150	516
TCSOPE0K336M8R-ZF1	8	6.3	10	33	±20	26.4	15	15	20	150	516
* TCSOPE1E335M8R-ZT1	25	20	29	3.3	±20	8.3	10	10	15	500	282

^{*} This specification has possibility of charge, due to underdevelopment product. Please ask for latest specification to our sales.

Packaging specifications



Reel dimensions



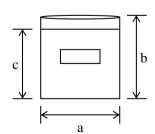
Damp proof package

1)One reel is packed in aluminum bag.

The size of aluminum bag is 240(a) x 250(b)mm.

The size up to 230(c)mm is to zipper.

- ②A desiccant is packed with a reel.
- 3The aluminum bag is heat-sealed.
- (4) The label of the same as the label on the reel is placed on the aluminum bag.



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSIII

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 - [a] Installation of protection circuits or other protective devices to improve system safety
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- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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